

# SGM3140B 500mA Buck/Boost Charge Pump LED Driver

## **GENERAL DESCRIPTION**

The SGM3140B is a current-regulated charge pump ideal for powering high brightness LEDs for camera flash applications. The charge pump can be set to regulate two current levels for Flash and Torch modes.

The SGM3140B automatically switches modes between step-up and step-down ensuring that LED current does not depend on the forward voltage. It switches at 2.2MHz, allowing the use of tiny components. The supply voltage ranges from 2.7V to 5.5V and is ideally suited for all applications powered by a single Li-Ion battery cell or three to four NiCd, NiMH, or Alkaline battery cells.

The SGM3140B also features a very low shutdown current, an automatic soft-start mode to limit inrush current, as well as over-current, over-voltage and over-thermal shutdown control.

A low current sense reference voltage (47mV) allows the use of small 0603 current sensing resistors.

The SGM3140B is available in Green TDFN-3×3-10L package and is specified over an ambient temperature range of -40°C to +85°C.

## **APPLICATIONS**

White LED Torch, Flash for Cell Phones, DSCs and Camcorders White LED Backlighting Generic Lighting, Flash and Strobe Applications General Purpose High Current Boost

## **FEATURES**

- Output Current Up to 500mA
- Up to 90% Efficiency in Torch Mode
- Adjustable Flash Mode Current
- Automatic Buck/Boost Mode Switchover
- Input Voltage Range: 2.7V to 5.5V
- Minimum External Components: No Inductors
- High Frequency Operation: 2.2MHz
- Low 47mV Reference for Low Loss Sensing
- I<sub>Q</sub> < 1µA in Shutdown
- Automatic Soft-Start Limits Inrush Current
- Low Input and Output Ripple and Low EMI
- Output Over-Voltage Protection
- Over-Current and Over-Temperature Protection
- Available in Green TDFN-3×3-10L Package

# TYPICAL APPLICATION





# 500mA Buck/Boost Charge Pump LED Driver

## PACKAGE/ORDERING INFORMATION

MODEL	ORDER NUMBER			MARKING INFORMATION	
SGM3140B	SGM3140BYD10G/TR	TDFN-3×3-10L	-40℃ to +85℃	Tape and Reel, 3000	SGM 3140BD XXXXX

NOTE: XXXXX = Date Code and Vendor Code.

# ABSOLUTE MAXIMUM RATINGS

VIN, VOUT	0.3V to 6V
V <sub>EN</sub>	0V to 5.5V
Output Current Pulse (Flash)	0.8A
Output Current Continuous (Torch)	0.4A
Package Thermal Resistance	
TDFN-3×3-10L, θ <sub>JA</sub>	57°C/W
Storage Temperature Range	40°C to +150°C
Junction Temperature	150°C
Operating Temperature Range	40°C to +85°C
Lead Temperature (Soldering 10 sec)	
	260°C
ESD Susceptibility	
HBM (EN Pin)	1000V
HBM (All other Pins)	2000V
MM	200V

#### NOTE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the latest datasheet.



# PIN CONFIGURATION (TOP VIEW)



# **PIN DESCRIPTION**

PIN	NAME	FUNCTION
1	VIN	Input Voltage for the Charge Pump. Decouple with $4.7\mu F$ or $10\mu F$ ceramic capacitor close to the pins of the IC.
2	C1	Positive Input for the External Flying Capacitor. Connect a ceramic $1\mu F$ capacitor close to the pins of the IC.
3	C2	Negative Input for the External Flying Capacitor. Connect a ceramic $1\mu F$ capacitor close to the pins of the IC.
4	FLASH	Logic Input to Toggle Operation between Flash and Torch Mode. In Torch mode FB is regulated to the internal 47mV reference. In Flash mode FB reference voltage can be adjusted by changing the resistor from RSET pin to ground. Choose the external current sense resistor ( $R_{SENSE}$ ) based on desired current in Torch mode and Flash mode.
5	EN	Shutdown Control Input. Connect to VIN for normal operation, connect to ground for shutdown. For normal operation, suggest connecting to VIN only after the VIN has settled if the VIN ramping up is slow.
6	RSET	RSET Pin. Connect a resistor from this pin to ground. When in Flash mode (FLASH = High) this resistor sets the current regulation point according to the following: $V_{FB} = (1.26V/R_{SET}) \times 10.2k\Omega.$
7	FB	Feedback Input for the Current Control Loop. Connect directly to the current sense resistor.
8	SGND	Internal Ground Pin. Control circuitry returns current to this pin.
9	PGND	Power Ground Pin. Flying capacitor current returns through this pin.
10	VOUT	Charge Pump Output Voltage. Decouple with an external capacitor. At least $1\mu$ F is recommended. If higher value capacitor is used, output ripple is smaller.
Exposed Pad	GND	Exposed pad should be soldered to PCB board and connected to GND.



# 500mA Buck/Boost **Charge Pump LED Driver**

# **ELECTRICAL CHARACTERISTICS**

 $(Full = -40^{\circ}C \text{ to } +85^{\circ}C, V_{IN} = 3.6V, C_{IN} = 4.7 \mu\text{F}, C_{OUT} = C_F = 1 \mu\text{F}, V_{SHDN} = V_{IN}, typical values at +25^{\circ}C, unless otherwise noted.)$ 

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	ТҮР	MAX	UNITS
Input Supply Voltage	V <sub>IN</sub>		Full	2.7		5.5	V
Quiescent Current	Ι <sub>Q</sub>	$V_{IN}$ = 2.7V to 5.5V, FLASH = 0V, $I_{LOAD}$ = 100µA	Full		0.3	3	mA
		FLASH = V <sub>IN</sub> , 2× Mode			2		
Shutdown Current	I <sub>SHDN</sub>	V <sub>EN</sub> = 0V, V <sub>IN</sub> = 5.5V				1	μA
Oscillator Frequency					2.2		MHz
Charge Pump Equivalent Resistance (2× mode)					5		Ω
Charge Pump Equivalent Resistance (1× mode)					0.6	0.8	Ω
FB Reference Voltage	V <sub>FB</sub>	FLASH = $V_{IN}$ , $R_{SET}$ = 86.6k $\Omega$	Full	134	150	162	mV
PB Reference voltage	V FB	FLASH = GND	Full	40	47	52	
FB Pin Current		V <sub>FB</sub> = 0.3V				1	μA
EN, FLASH Logic Low			Full			0.4	V
EN, FLASH Logic High			Full	1.3			V
EN, FLASH Pin Current			Full			1	μA
V <sub>OUT</sub> Turn-On Time		$V_{IN}$ = 3.6V, FB within 90% of regulation			250		μs
Thermal Shutdown Temperature					145		°C



## 500mA Buck/Boost Charge Pump LED Driver

# **TYPICAL PERFORMANCE CHARACTERISTICS**

 $C_{\text{IN}}$  = 10µF,  $C_{\text{OUT}}$  = 4.7µF,  $C_{\text{F}}$  = 1µF, unless otherwise noted.



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# **TYPICAL APPLICATION**

The SGM3140B can be used with multiple LEDs in parallel as shown in Figure 1. For best performance, the LEDs should be in a single package, preferably from a single die to have better matching for forward voltage  $V_F$  for a given forward current  $I_F$ . In practice, if the  $V_F$  of one LED is higher than the others, it will consume a larger  $I_F$ , which will raise its temperature which will then cause its  $V_F$  to reduce, correcting the imbalance. The overall current will be the sum of the individual currents, for example  $I_{TOTAL} = 4 \times I_{LED}$ .



Figure 1. Multiple LEDs Flash Circuit

# OPERATION

The SGM3140B is a charge pump regulator designed for converting a Li-Ion battery voltage of 2.7V to 4.2V to drive a white LED used in digital still camera flash and torch applications. The SGM3140B has two modes of operation which are pin selectable for either Flash or Torch. Both modes can be used continuously unless thermal shutdown happens. Torch is often used for several seconds in a digital still camera "movie" mode.

The SGM3140B also has two modes of operation to control the output current: the 1× mode and 2× mode. Operation begins after the enable pin EN receives a logic high, the band-gap reference wakes up after 50µs, and then SGM3140B goes through a soft-start mode designed to reduce inrush current. The SGM3140B starts in the 1× mode, which acts like a linear regulator to control the output current by continuously monitoring the feedback pin FB. In 1× mode, if the SGM3140B auto detects a dropout condition, which is when the FB pin is below the regulation point for more than 15µs, the SGM3140B automatically switches to the 2× mode. The SGM3140B remains in the 2× mode until one of four things happens:

- 1) The enable pin EN has been toggled.
- 2) The FLASH pin has changed from high to low.
- 3)  $V_{IN}$  is cycled or  $V_{IN}$  is at least 1V above  $V_{OUT}$ .
- 4) A thermal fault occurs.

The 2× mode is the charge pump mode where the output can be pumped as high as two times the input voltage, provided the output does not exceed the maximum voltage for the SGM3140B, which is internally limited to about 5.5V. In the 2× mode, as in the 1× mode, the output current is regulated by the voltage at the FB pin.

In the Torch mode, (FLASH = "GND") the FLASH pin is set to logic low and the SGM3140B FB pin regulates to 47mV output:

When in Flash mode, (FLASH = "High"), the FB regulation voltage is set by the resistor  $R_{SET}$  connected between the RSET pin and SGND and the equation:

$$V_{FB}$$
 = (1.26V/  $R_{SET}$ ) × 10.2k $\Omega$  (Flash Mode)

Where 1.26V is the internal band-gap reference voltage and 10.2k $\Omega$  is an internal resistance used to scale the RSET current. Typical values of R<sub>SET</sub> are 42k $\Omega$  to 170k $\Omega$  for a range of V<sub>FB</sub> = 300mV to 75mV in Flash mode.

The output current is then set in either Flash or Torch mode by the equation:

$$I_{OUT} = V_{FB} / R_{SENSE}$$



## **APPLICATION INFORMATION**

#### **Over-Temperature Protection**

When the temperature of SGM3140B rises above 145°C, the over-temperature protection circuitry turns off the output switches to prevent damage to the device. If the temperature drops back down below 130°C, the part automatically recovers and executes a soft-start cycle.

#### **Over-Voltage Protection**

The SGM3140B has over-voltage protection. If the output voltage rises above the 5.5V threshold, the over-voltage protection shuts off all of the output switches to prevent the output voltage from rising further. When the output decreases below 5.2V, the device resumes normal operation.

#### **Over-Current Protection**

The over-current protection circuitry monitors the average current out of the  $V_{OUT} = 47 \text{mV}$  (Torch Mode) pin. If the average output current exceeds approximately 0.8Amp, then the over-current protection circuitry shuts off the output switches to protect the chip.

#### **Component Selection**

The SGM3140B charge pump circuit requires 3 capacitors:  $4.7\mu$ F input,  $1\mu$ F output and  $1\mu$ F flying capacitors are typically recommended. For the input capacitor, a larger value of  $10\mu$ F will help reduce input voltage ripple for applications sensitive to ripple on the battery voltage. All the capacitors should be surface mount ceramic for low lead inductance necessary at the 2.2MHz switching frequency of the SGM3140B and to obtain low ESR, which improves bypassing on the input and output and improves output voltage drive by reducing output resistance. Ceramic capacitors with X5R or X7R temperature grade are recommended for most applications.

The input and output capacitors should be located as close to the VIN and VOUT pins as possible to obtain best bypassing, and the returns should be connected directly to the PGND pin or to the thermal pad ground located under the SGM3140B. The flying capacitor should be located as close to the C1 and C2 pins as possible.

To obtain lower output ripple, the  $C_{OUT}$  value can be increased from  $1\mu$ F to  $2.2\mu$ F or  $4.7\mu$ F with a corresponding decrease in output ripple. For output currents of 400mA to 500mA, the recommended C<sub>F</sub> flying capacitor value of  $1\mu$ F should be used. Output currents in Flash of 100mA to 400mA can use a  $0.47\mu$ F C<sub>F</sub> but a minimum  $1\mu$ F C<sub>OUT</sub> is still needed.

#### **Resister Selection**

The sense resistor  $R_{SENSE}$  is determined by the value needed in the Torch mode for the desired output current by the equation:

$$R_{SENSE} = V_{FB} / I_{OUT}$$
 where  $V_{FB} = 47 mV$  (Torch Mode)

Once the  $R_{SENSE}$  resistor has been selected for Torch mode, the  $V_{FB}$  voltage can be selected for Flash mode using the following equation:

 $V_{FB}$  =  $I_{OUT}$  ×  $R_{SENSE}$  (Flash Mode) where  $I_{OUT}$  is for Flash Mode.

Next, the  $R_{SET}$  resistor can be selected for Flash mode using the following equation:

$$R_{SET} = (1.26V/V_{FB}) \times 10.2k\Omega$$
 (Flash Mode)

For an example of 155mA Torch mode and 500mA Flash mode, the values  $R_{SENSE} = 0.30\Omega$ ,  $V_{FB} = 150mV$  (Flash Mode), and  $R_{SET} = 86.6k\Omega$  are calculated. The power obtained in the Flash mode would be:

$$P_{FLASH} = V_{FB} \times I_{OUT} = 150 \text{mV} \times 500 \text{mA} = 75 \text{mW}.$$

The typical 0603 surface mount resistor is rated 1/10 Watt continuous power and 1/5 Watt pulsed power, more than enough for this application. For other applications, the  $P_{FLASH}$  power can be calculated and resistor size selected. The  $R_{SENSE}$  resistor is recommended to be size 0603 for most applications.

The range of typical resistor values and sizes are shown here in Table 1.



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Table 1: Resistor Values and Sizes

PART REFERENCE	VALUE	TOLERANCE	SIZE	MANUFACTURERS
R <sub>SET</sub>	68kΩ	5%	0402	any
R <sub>SET</sub>	75kΩ	5%	0402	any
R <sub>SET</sub>	82kΩ	5%	0402	any
R <sub>SET</sub>	91kΩ	5%	0402	any
R <sub>SET</sub>	100kΩ	5%	0402	any
R <sub>SET</sub>	110kΩ	5%	0402	any
R <sub>SET</sub>	120kΩ	5%	0402	any
R <sub>SET</sub>	130kΩ	5%	0402	any
R <sub>SET</sub>	140kΩ	5%	0402	any
R <sub>SET</sub>	150kΩ	5%	0402	any
R <sub>SENSE</sub>	0.22Ω	5%	0603	Panasonic or Vishay
R <sub>SENSE</sub>	0.27Ω	5%	0603	Panasonic or Vishay
R <sub>SENSE</sub>	0.33Ω	5%	0603	Panasonic or Vishay
R <sub>SENSE</sub>	0.39Ω	5%	0603	Panasonic or Vishay
R <sub>SENSE</sub>	0.47Ω	5%	0603	Panasonic or Vishay



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# **EVALUATION BOARD LAYOUT**



### **Printed Circuit Board Layout Recommendations**

Follow the PCB layout guidelines for optimal performance:

1. Place the flying capacitor CF as close to the chip as possible; otherwise 2× mode performance will be compromised. Also keep analog components away from this capacitor.

2. Place input and output decoupling capacitors as close to the chip as possible to reduce switching noise and output ripple.

3. The power traces, consisting of the VIN/GND trace, the VOUT trace and the WLED trace should be kept short and wide. Also minimize the feedback loop area (consisting of WLED/FB) small.

4. Connect the exposed pad to the GND plane to achieve the best power dissipation.



E1

# PACKAGE OUTLINE DIMENSIONS

**TDFN-3×3-10L** 



A1 – A2

SIDE VIEW

Δ



RECOMMENDED LAND PATTERN (Unit: mm)

Symbol		nsions meters	Dimensions In Inches		
	MIN	МАХ	MIN	MAX	
A	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203	B REF	0.008 REF		
D	2.900	3.100	0.114	0.122	
D1	2.300	2.600	0.091	0.098	
E	2.900	3.100	0.114	0.122	
E1	1.500	1.800	0.063	0.071	
k	0.200	0.200 MIN 0.008 MIN			
b	0.180	0.300	0.007	0.012	
е	0.500	) TYP	0.020	) TYP	
L	0.300	0.500	0.012 0.020		



# TAPE AND REEL INFORMATION

### **REEL DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TDFN-3×3-10L	13"	12.4	3.35	3.35	1.13	4.00	8.00	2.00	12.00	Q1



### **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

#### **KEY PARAMETER LIST OF CARTON BOX**

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13"	386	280	370	5	

